

# RZ/T2M Group

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### Introduction

This application note uses the general purpose PWM timer (GPT) phase counting mode feature of the RZ/T2 M.

This is a sample program that counts the number of pulses of a two-phase encoder (A phase, B phase) using the phase counting mode (phase counting mode 1) function.

The main functions of the GPT Phase Count Mode (GPT Phase Count) sample program are shown below.

- 1. Command input from the terminal acquires the count value of phase A and B pulses of the 3-phase encoder pulse number and resets the count value
- 2. After the pulse of phase Z is acquired, the pulse counts of phase A and B are cleared.

### **Target Device**

RZ/T2M Group

When applying the sample program covered in this application note to another microcomputer, modify the program according to the specifications for the target microcomputer and conduct an extensive evaluation of the modified program.



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### 1. Specifications

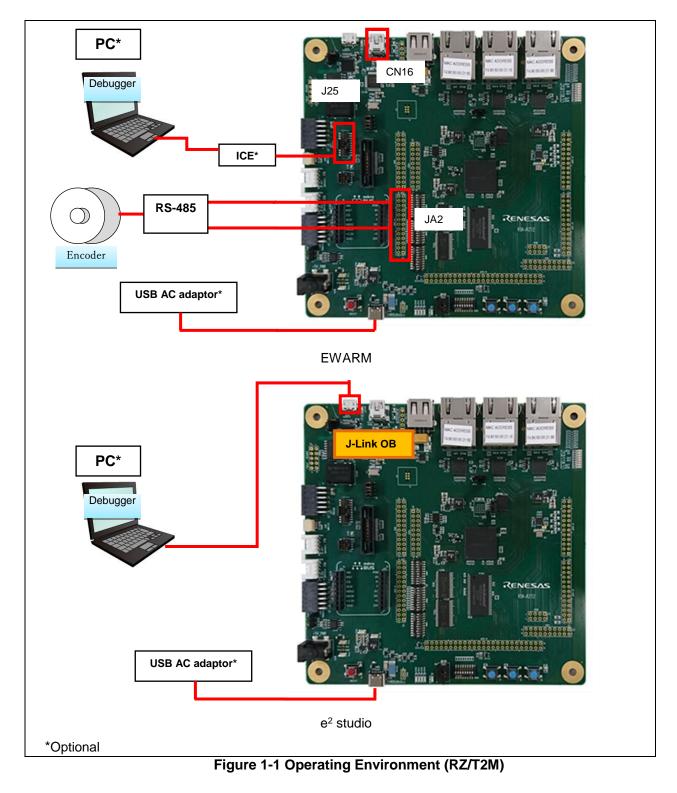
Table 1-1 lists the peripheral functions to be used and their applications, Table 1-1 shows the operating environment.

Peripheral Function	Application
Serial communication interface (SCI)	Used for setting instructions from the terminal. (Get or Reset instructions)
General PWM Timer (GPT)	Phase counting mode 1.
	The GTETRGA pin is used for Z-phase.

#### **Table 1-1 Peripheral Functions and Applications**



# 1.1 RZ/T2M operating environment





Function	Connector	Pin	Signal	Condition
SCI	CN16	TXD0(P16_5)	UART_USB_TX	USB on Renesas Starter Kit+
		RXD0(P16_6)	UART_USB_RX	for RZ/T2M
GPT	JA2-A-10	GTIOC1A(P17_6)	SCK3	Pin header on Renesas
	JA2-A-14	GTIOC1B(P18_1)	M1_UN	Starter Kit+ for RZ/T2M
	JA2-A-24	GTETRGA(P17_3)	ENCIF5	

### 1.1.1 Switch Setting

■SW4

1	2	3	4	5	6	7	8
ON	OFF	ON	ON	OFF	OFF	OFF	OFF

∎SW5

1	2	3	4	5	6	7	8	9	10
OFF	OFF	OFF	ON	OFF	OFF	OFF	OFF	ON	OFF

■SW6

1	2	3	4	5	6	7	8	9	10
OFF									

### 1.1.2 Jumper Setting

### Table 1-2 Renesas Starter Kit+ for RZ/T2M jumper setting

No	Jumper number	Setting
1	CN17	Jumper 2-3 short
2	J9	Jumper 1-2 short (When using JTAG)
		Jumper 1-2 open (When using J-Link OB)



### 2. Operating Environment

The sample program covered in this application note is for the environment below.

Item	Description
Board	Renesas Starter Kit+ for RZ/T2M
MPU	RZ/T2M Group(R9A07G075M24GBG)
Encoder(Motor)	MB057GA140
Conversion board	RS-485 board
Operating frequency	CPU Core0 : 800MHz(Arm <sup>®</sup> Cortex <sup>®</sup> -R52)
Operating voltage	3.3V/1.8V/1.1V
Integrated development environment	Manufactured by IAR Systems
	Embedded Workbench <sup>®</sup> for Arm Version 9.32.2
	Manufactured by RENESAS
	e <sup>2</sup> studio 2023-07 (23.07.0) (R20230714-1443)
Emulator	Manufactured by IAR Systems
	I-jet
	Manufactured by SEGGER
	J-Link Base Ver.11.0
Flexible Software Package (FSP)	Version 1.3.0

#### Table 2-1 Operating Environment



### 3. Peripheral Functions

The basics of the operating modes, Serial communication interface (SCI), General PWM Timer (GPT), and general I/O ports are described in the RZ/T2M Group User's Manual.



### 4. Hardware

### 4.1 Hardware Configuration

The hardware configuration is shown below.

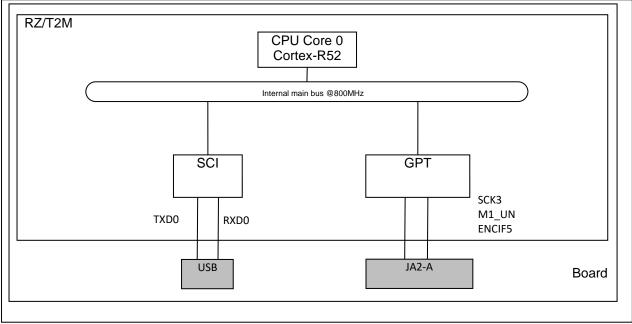


Figure 4-1 Hardware Configuration (RZ/T2M)



### 4.2 Pins

The following table shows the pins and functions.

### Table 4-1 Pins and Functions (RZ/T2M)

Pin name	I/O	Function
TXD0(P16_5)	Output	Send data to terminal
RXD0(P16_6)	Input	Receive data from terminal
SCK3 (P17_6)	Input	3-phase encoder Phase A signal
M1_UN (P18_1)	Input	3-phase encoder Phase B signal
ENCIF(P17_3)	Input	3-phase encoder Phase Z signal



### 5. Software

### 5.1 Operation Outline

This software uses serial communication interface (SCI) asynchronous communication to communicate with the host PC via COM port of RS-232 interface, and changes the bit mode by changing the program.

Do one of the following with a command from the terminal software on the host PC.

• When you enter the "g" command, the count value is obtained. (When the pulse of phase Z is acquired,

the count value is set to 0.)

• When you enter the "r" command, the count value is reset to 0.

### 5.2 System Block Diagram

Figure 5-1 shows the software configuration of this sample program.

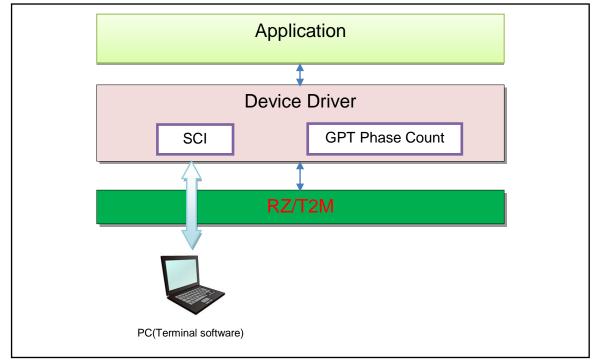


Figure 5-1 Software Configuration



### 5.3 Application

### 5.3.1 Constants

Table 5-1 shows the Constants

#### **Table 5-1 Constants**

Constant Name	Setting Value	Description
CHARACTER_LENGTH_BYTE	20	Maximum data length of character string (unit: Byte)



### 5.3.2 Main function

Figure 5-2 shown flowchart of the main function flowchart

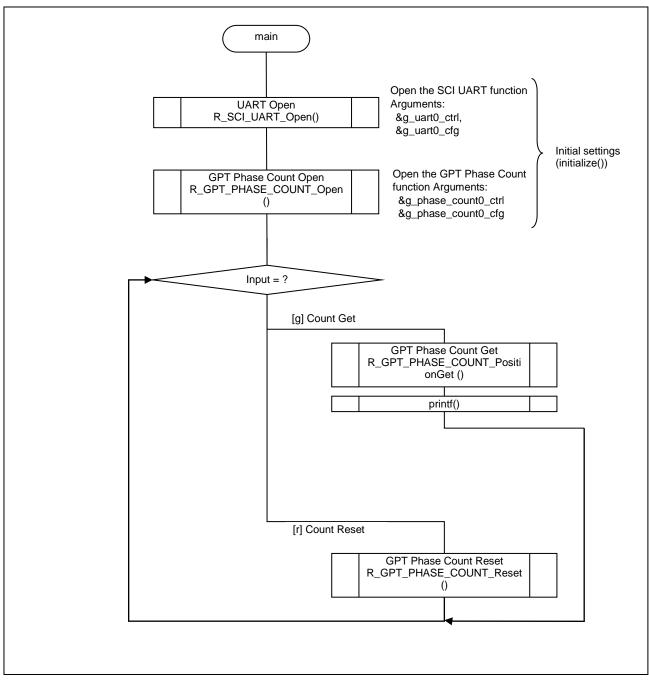


Figure 5-2 FLOWCHART (Initialize, Mode select)



### 5.3.3 Functions List

Table 5-2 shows the functions.

#### Table 5-2 Function list

Layer / Block	Function Name	Chapter
Application	hal_entry ()	5.3.3.1
	initialize ()	5.3.3.2
	sci_uart_callback ()	5.3.3.3
	handle_error ()	5.3.3.4



### 5.3.3.1 hal\_entry

hal_entry		
Synopsis	Master side	main routine of the sample software
Header	hal_data.h	
Declaration	void hal_en	try(void)
Description	This is the r	naster side main routine of the sample software.
Arguments	void	none
Return values	-	none

#### 5.3.3.2 initialize

initialize			
Synopsis	Initialize		
Header	-		
Declaration	static void initialize	(void)	
Description	Initialize for the foll • SCI_UART • SCI_UART_Ba • GPT Phase Co	aud	
Arguments	void	none	
Return values	-	none	

### 5.3.3.3 sci\_uart\_callback

sci_uart_callback		
Synopsis	Callback function for sci_uart in	struction
Header	-	
Declaration	void sci_uart_callback(uart_call	back_args_t* p_args)
Description	Receive the callback of the sci_ callback.	uart instruction and process the events in the received
Arguments Return values	uart_callback_args_t* p_args -	A pointer to the Arguments information none

### 5.3.3.4 handle\_error

handle_error		
Synopsis	Error processing	
Header	-	
Declaration	static void handle_e	error(fsp_err_t err)
Description	Performs processin	g when an error occurs in processing using the FSP driver.
Arguments	fsp_err_t err	fsp error content
Return values	-	none



### 5.4 FSP driver functions

#### 5.4.1 SCI module functions

Table 5-3 lists the functions to be used.

Please refer to "RZ/T2M Flexible Software Package Documentation" for the function details.

Function	Description
R_SCI_UART_Open	SCI_UART open function
R_SCI_UART_Close	SCI_UART close function
R_SCI_UART_Read	Read from UART device
R_SCI_UART_Write	Write to UART device
R_SCI_UART_CallbackSet	User callback function
R_SCI_UART_BaudSet	Update SCI_UART baud rate
R_SCI_UART_InfoGet	Provides driver information
R_SCI_UART_Abort	Provides an API to abort an in-progress transfer
R_SCI_UART_BaudCalculate	Calculate the set value of the baud rate register
R_SCI_UART_VersionGet	Get the API version number

### Table 5-3 Functions

### 5.4.2 GPT Phase Count module functions

Table 5-4 lists the functions to be used

Please refer to "RZ/T2M Flexible Software Package Documentation" for the function details.

#### **Table 5-4 Functions**

Function	Description
R_GPT_PHASE_COUNT_Open	GPT Phase Count open function
R_GPT_PHASE_COUNT_Stop	Stop the GPT Phase Count timer
R_GPT_PHASE_COUNT_Start	Start the GPT Phase Count timer
R_GPT_PHASE_COUNT_Reset	Reset the GPT Phase Count timer
R_GPT_PHASE_COUNT_PositionSet	Sets the GPT Phase Count timer counter value
R_GPT_PHASE_COUNT_PositionGet	Gets the GPT Phase Count timer counter value
R_GPT_PHASE_COUNT_CallbackSet	User callback function
R_GPT_PHASE_COUNT_Close	GPT Phase Count close function
R_GPT_PHASE_COUNT_VersionGet	Get the API version number



#### 6. How the sample application works

#### 6.1 How the EWARM version works

Build the sample program and load it into RAM using IAR Embedded Workbench.

Note: Please install FSP Smart Configurator in advance.

1. Open a sample project.

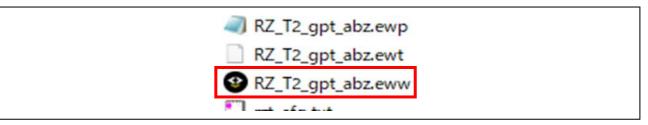


Figure 6-1 Open sample project

2. Open "RZ Smart Configurator".

Note: Smart Configurator must be registered in advance in [Tools] - [Configure Tools...].

[Tools] – [Configure Tools...] select [New] and enter the following:

Menu Text : RZ Smart Configurator

Command : " Describe the absolute path of rasc.exe installation "

- Argument : --compiler IAR configuration.xml
- Initial Directory : \$PROJ\_DIR\$

		_	
Project I-jet	Тоо	ls Window Help	
🖴   🕹 🗈 (	٥	Options	
		Filename Extensions	
		Configure Viewers	
		Configure Custom Argument Variables	
3K_gpt_phas	10	Configure Tools	
/are :onfiguration		IAR Project Converter	
inents ated Data		RZ Smart Configurator	
m Entry		Device Partition Manager	

#### Figure 6-2 RZ Smart Configurator



#### 3. Click "Generate Project Content" to generate the code.

[FSP_Project] FSP Configuration ×				- F
Stacks Configuration				Generate Project Conten
Threads 🕢 New Thread 🔊 Remove 📄	HAL/Common Stacks		🗿 New Stack > 🚊	🗄 Extend Stack > 🛛 🔊 Remove
<ul> <li>✓ MAL/Common</li> <li>              g_iopotl/O Port Driver on r_ioport</li></ul>	<ul> <li>g_ioport I/O Port Driver on r_ioport</li> <li>3</li> </ul>	<ul> <li>Phase-Count Driver on r_gpt_phase_count</li> <li>g_timero Timer Driver on r_gpt</li> <li>g_timero Timer Driver</li> </ul>	g_uart0 UART Driver on     g     Add DMAC Driver for     Transmission     [Recommended but     optional]	Add DMAC Driver for Reception [Not recommended]
Objects බ New Object > ඬ Remove	¢			,

#### Figure 6-3 Code generator

4. Select "Rebuild All" from the "Project" menu to rebuild the project.

Proj	ject I-jet	Tools	Window	Help		
	Add Files.					
	Add Grou	p				
[+]	Import File	e List				
	Add Proje	ct Conne	ection			
	Edit Confi	guration	15			
×	Remove					
<b>t</b> )	Create Ne	w Project	t			
6	Add Existi	ng Proje	ct			
Φ	Options			Alt+F7		
	Version Co	ontrol Sy	stem	I	•	
0	Make			F7		
	Compile			Ctrl+F7		
9	Rebuild A	II				
₫	Clean					
P	Batch buil	d		F8		

Figure 6-4 Rebuild All



5. After connecting the board and I-jet, select "Download and Debug" from the "Project" menu.

Pro	roject I-jet Tools Windo	w Help
	Add Files	
	Add Group	
[4]	Import File List	
	Add Project Connection	
	Edit Configurations	
×	Remove	
1	Consta New Desired	
10	Add Existing Project	
•	Doptions	Alt+F7
	Version Control System	×
•	Make	F7
	Compile	Ctrl+F7
	Rebuild All	
<u>A</u>	Clean	
	Batch build	F8
	Clean Browse Information	
	C-STAT Static Analysis	•
8	Stop Build	Ctrl+Break
0	Download and Debug	Ctrl+D
	Debug without Downloadi	ing
•	Attach to Running Target	
G	Make & Restart Debugger	CtrI+R
C	Restart Debugger	Ctrl+Shift+R
	Download	+

Figure 6-5 Download and Debug

6. Select "Go" from the "Debug" menu to run the program.

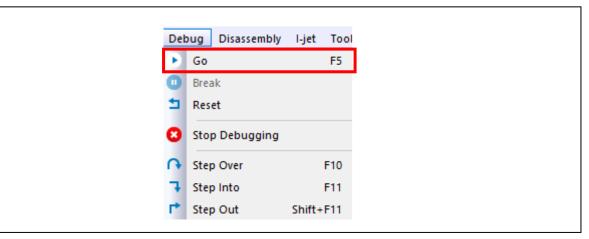


Figure 6-6 Run sample program



#### 6.2 How the GCC version works

Build the sample program and load it into RAM using Renesas Electronics e<sup>2</sup>studio.

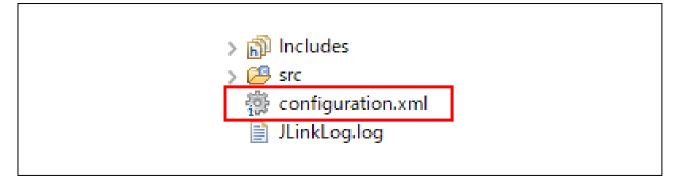
Note: Please install e<sup>2</sup>studio and apply FSP\_Packs in advance.

 Import the sample project. After launching e2studio, select [File] → [Import] → [Existing Projects into Workspace]. Check [select archive file], select "RZ\_T2\_gpt\_abz.zip" compressed folder → select [Finish].

mport Projects         Select a directory to search for existing Eclipse projects.         Select root directory:         Select archive file:         C:¥r01an7289xx0100-rzt2m-gpt-abz¥gcc¥RZ_T2_gpt_abzzip	Browse
Select root directory:	Browse
	Browse
Select archive file:     C:¥r01an7289xx0100-rzt2m-gpt-abz¥gcc¥RZ_T2_gpt_abz.zip	
	Browse
Projects:	
Z_T2_gpt_abz (RZ_T2_gpt_abz/)	Select All
	Deselect All
	Refresh
Options	
Search for nested projects	
Copy projects into workspace	
Close newly imported projects upon completion Hide projects that already exist in the workspace	
Working sets	
Add project to working sets	New
Working sets:	Select

Figure 6-7 Sample program import

2. Open "configuration.xml" of the project.



#### Figure 6-8 Configuration.xml



3. Click "Generate Project Content" to generate the code.

Threads	🔕 New Thread 🔹 Remove 📄	HAL/Common Stacks			New Stack > 🚔 Extend Stack >	🔬 Remo
🕀 g_uart0 UART	<sup>3</sup> ort Driver on r_ioport Driver on r_sci_uart Driver on r_gpt_phase_count	<ul> <li>     g_ioport I/O Port Driver on r_ioport     </li> </ul>	g_uart0 UART Driver on     g_uart0 UART Driver on     Add DMAC Driver for     Transmission     [Recommended but     optional]	Add DMAC Driver for Reception [Not recommended]	<ul> <li>Phase-Count Driver on r_gpt_phase_count</li> <li> <ol> <li> <u>1</u></li></ol></li></ul>	
Objects	New Object > Remove					

### Figure 6-9 Code Generation

4. Select your project and run the build.

	New Go Into	>
	Open in New Window Show In	Alt+Shift+W >
	Сору	Ctrl+C
Ē	Paste	Ctrl+V
*	Delete	Delete
	Source	>
	Move	
	Rename	F2
2	Import	
r s	Export	
	Renesas FSP Export	>
	Build Project	
	Clean Project	
\$	Refresh	F5

Figure 6-10 Run build



- 5. After connecting the board and J-Link, start debugging by following the steps below.
  - I. Select "Debug Configurations..." from the "Run" menu.

Run	Window Help	
	Renesas Debug Tools	>
Q,	Run	Ctrl+F11
梅	Debug	F11
	Run History	>
0	Run As	>
	Run Configurations	
	Debug History	>
な	Debug As	>
	Debug Configurations	
	Breakpoint Types	>
0	Toggle Breakpoint	Ctrl+Shift+B
Θ	Toggle Line Breakpoint	
65	Toggle Watchpoint	
0	Toggle Method Breakpoint	
`Q	Skip All Breakpoints	
×	Remove All Breakpoints	
	External Tools	

Figure 6-11 Debug Configurations

II. In the [Renesas DBG Hardware Debugging]  $\rightarrow$  [RZ\_T2gpt.elf] item, press [Debug].

s Search Project.	Browse
Search Project.	
Search Project	
Search Project	Browse_
Search Project	Browse_
Search Project.	. Browse
	~
Revert	Apply
	Revert

Figure 6-12 Run debug



Т

III. The following dialog will be displayed. Please switch to the debug screen.

📴 Con	firm Perspective Switch X
?	This kind of launch is configured to open the Debug perspective when it suspends. This Debug perspective supports application debugging by providing views for displaying the debug stack, variables and breakpoints.
	Switch to this perspective?
Rem	ember my decision Switch No

Figure 6-13 Switch debug screen

6. Debugging starts when you press the "Resume" button, and the program is interrupted at "hal\_entry ();" in main.c. Press the "Resume" button again to run the program.



#### 6.3 How the sample application works

This sample program will communicate with a PC, so the preparations for its execution will be explained.

1. Start the terminal software on the host PC and set the serial port as follows.

(When using COM3 with Tera Term)

Tera Term: Serial port setu	-	
	COM3	, New setting
Speed:	115200	·
Data:	8 bit	, Cancel
Parity:	none	·
Stop bits:	1 bit	Help
Flow control:	none	•
Transmit c	lelay msec/char	0 msec/line

Figure 6-14 Serial port settings

#### 6.3.1 Operation

When the sample program is executed and communication becomes possible, the sample program menu will be displayed on the terminal software.

Note: Enter commands in lower case only

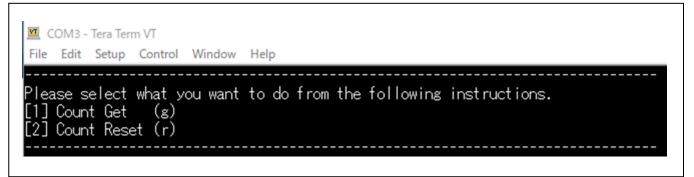


Figure 6-15 Display of terminal software after running the sample program



#### 6.3.1.1 Count Get operation

In the state of Figure 6-15 input "g" and press Enter to read the GPT counter value.



Figure 6-16 Count Get mode input example

#### 6.3.1.2 Count Reset operation

In the state of Figure 6-15, input "r" and press Enter to clear the GPT counter value.



Figure 6-17 Count Reset mode input example



#### 7. About phase counting mode

The operation of each mode of the phase counting mode is shown below.

### 7.1 Phase counting mode 1

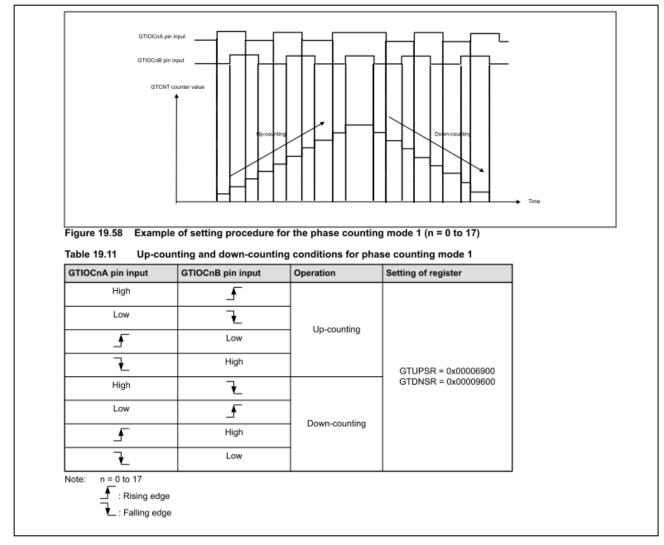


Figure 7-1 Phase count mode 1



# **Revision History**

		Description	
Rev.	Date	Page	Summary
1.00	Mar.14,2024	-	First edition issued



#### General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power is supplied until the power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V<sub>IL</sub> (Max.) and V<sub>IH</sub> (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V<sub>IL</sub> (Max.) and V<sub>IH</sub> (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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